

# TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C TIBPAL16L8-30M, TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE **IMPACT**™ **PAL**® CIRCUITS

SRPS059A – FEBRUARY 1984 – REVISED DECEMBER 2010

- **High-Performance Operation:**  
Propagation Delay  
C Suffix . . . 25 ns Max  
M Suffix . . . 30 ns Max
- **Functionally Equivalent, but Faster Than**  
PAL16L8A, PAL16R4A, PAL16R6A, and  
PAL16R8A
- **Power-Up Clear on Registered Devices (All**  
Register Outputs Are Set High, but Voltage  
Levels at the Output Pins Go Low)
- **Package Options Include Both Plastic and**  
Ceramic Chip Carriers in Addition to Plastic  
and Ceramic DIPs
- **Dependable Texas Instruments Quality and**  
Reliability

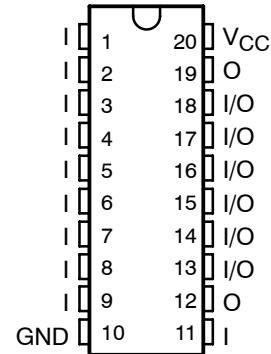
| DEVICE  | I<br>INPUTS | 3-STATE<br>O<br>OUTPUTS | REGISTERED<br>Q<br>OUTPUTS | I/O<br>PORTS |
|---------|-------------|-------------------------|----------------------------|--------------|
| PAL16L8 | 10          | 2                       | 0                          | 6            |
| PAL16R4 | 8           | 0                       | 4 (3-state<br>buffers)     | 4            |
| PAL16R6 | 8           | 0                       | 6 (3-state<br>buffers)     | 2            |
| PAL16R8 | 8           | 0                       | 8 (3-state<br>buffers)     | 0            |

## description

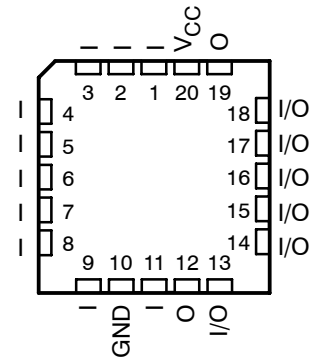
These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These **IMPACT**™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

The TIBPAL16' C series is characterized from 0°C to 75°C. The TIBPAL16' M series is characterized for operation over the full military temperature range of -55°C to 125°C.

TIBPAL16L8'  
C SUFFIX . . . J OR N PACKAGE  
M SUFFIX . . . J OR W PACKAGE  
(TOP VIEW)



TIBPAL16L8'  
C SUFFIX . . . FN PACKAGE  
M SUFFIX . . . FK PACKAGE  
(TOP VIEW)



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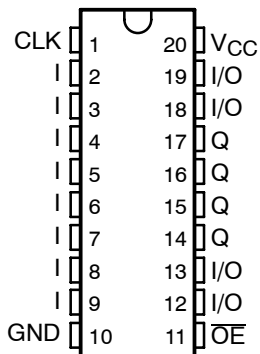
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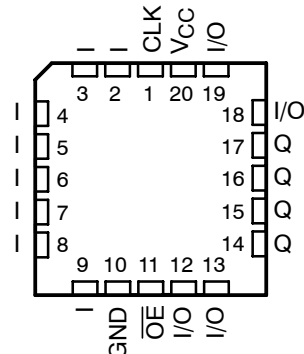
**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C  
TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M  
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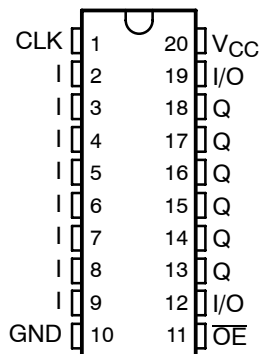
**TIBPAL16R4'**  
**C SUFFIX ... J OR N PACKAGE**  
**M SUFFIX ... J OR W PACKAGE**  
**(TOP VIEW)**



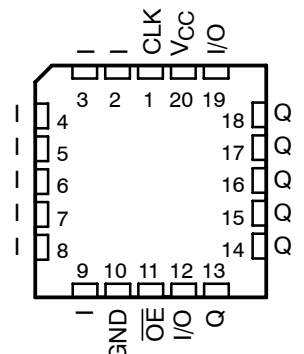
**TIBPAL16R4'**  
**C SUFFIX ... FN PACKAGE**  
**M SUFFIX ... FK PACKAGE**  
**(TOP VIEW)**



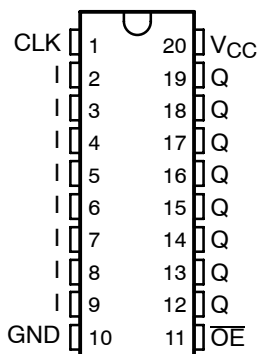
**TIBPAL16R6'**  
**C SUFFIX ... J OR N PACKAGE**  
**M SUFFIX ... J OR W PACKAGE**  
**(TOP VIEW)**



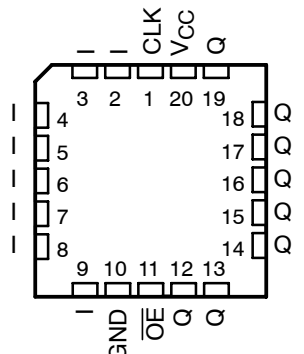
**TIBPAL16R6'**  
**C SUFFIX ... FN PACKAGE**  
**M SUFFIX ... FK PACKAGE**  
**(TOP VIEW)**



**TIBPAL16R8'**  
**C SUFFIX ... J OR N PACKAGE**  
**M SUFFIX ... J OR W PACKAGE**  
**(TOP VIEW)**



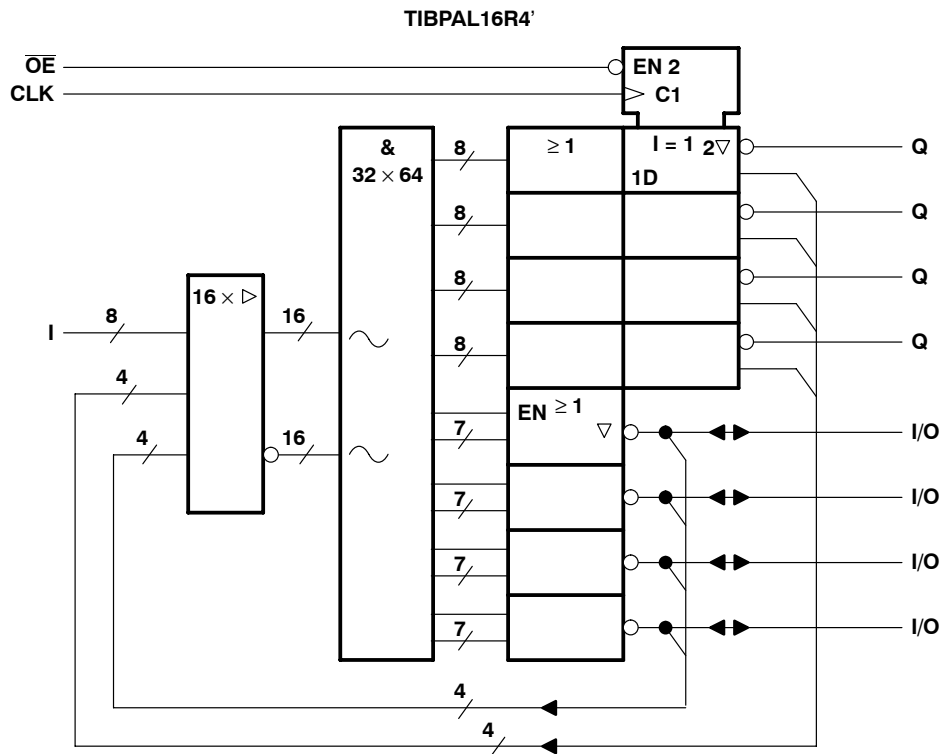
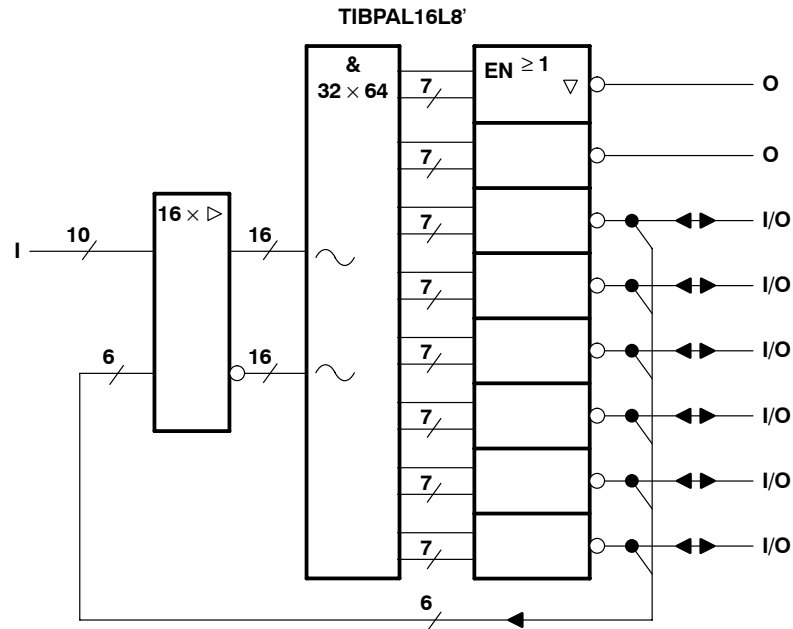
**TIBPAL16R8'**  
**C SUFFIX ... FN PACKAGE**  
**M SUFFIX ... FK PACKAGE**  
**(TOP VIEW)**



TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C  
 TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ PAL® CIRCUITS**

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functional block diagrams (positive logic)

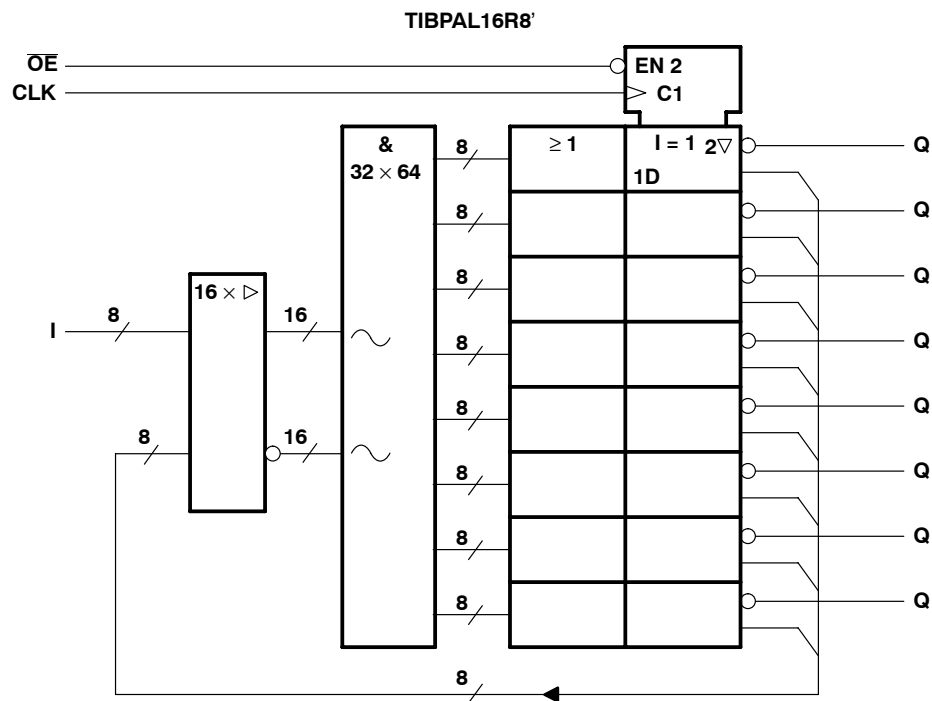
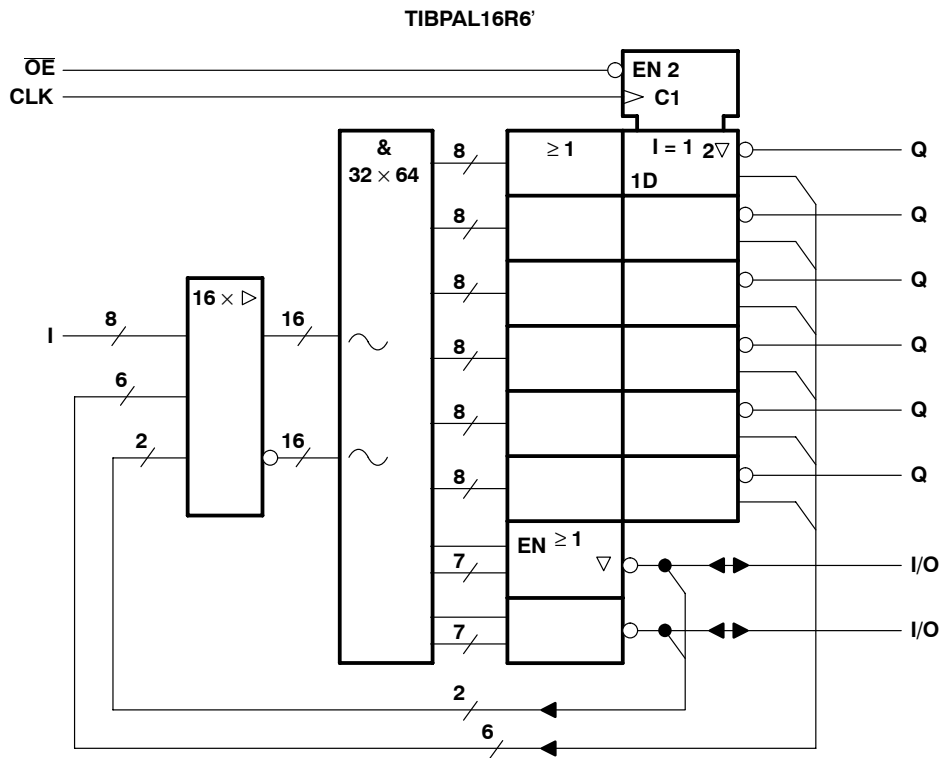


~ denotes fused inputs

**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
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**functional block diagrams (positive logic)**



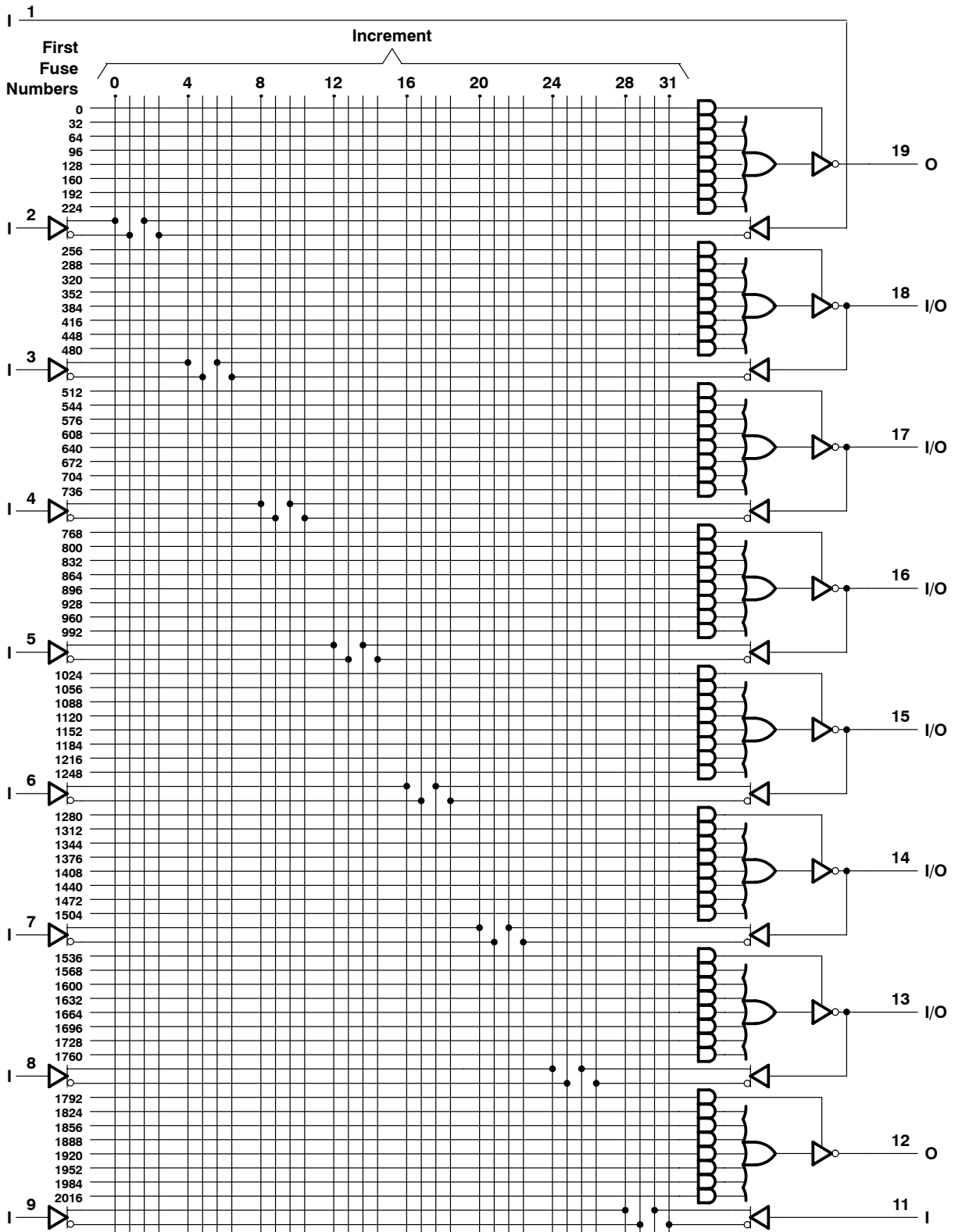
~ denotes fused inputs



TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C  
 TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M  
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logic diagram (positive logic)



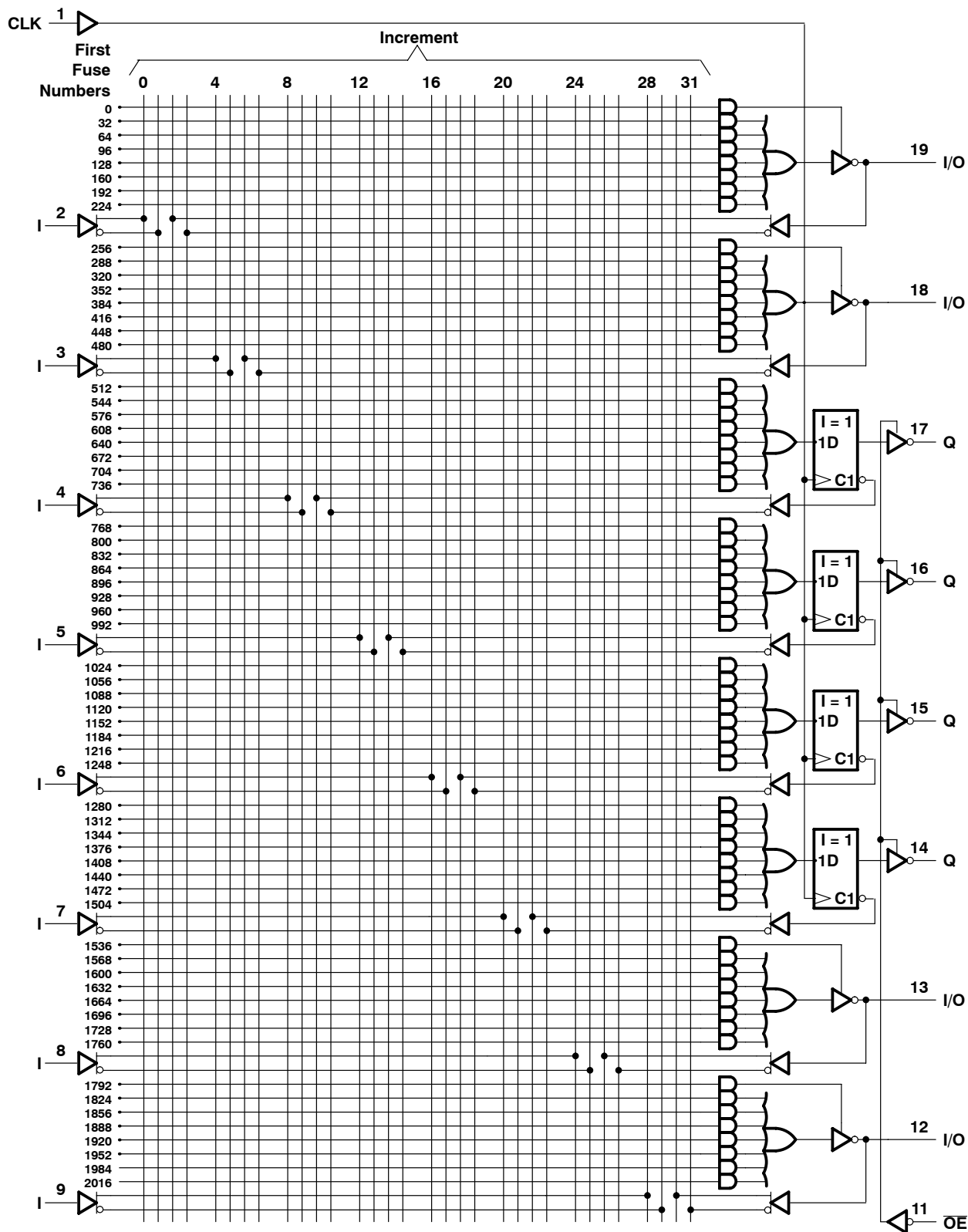
Fuse number = First fuse number + Increment



**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C  
 TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M  
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**logic diagram (positive logic)**



Fuse number = First fuse number + Increment

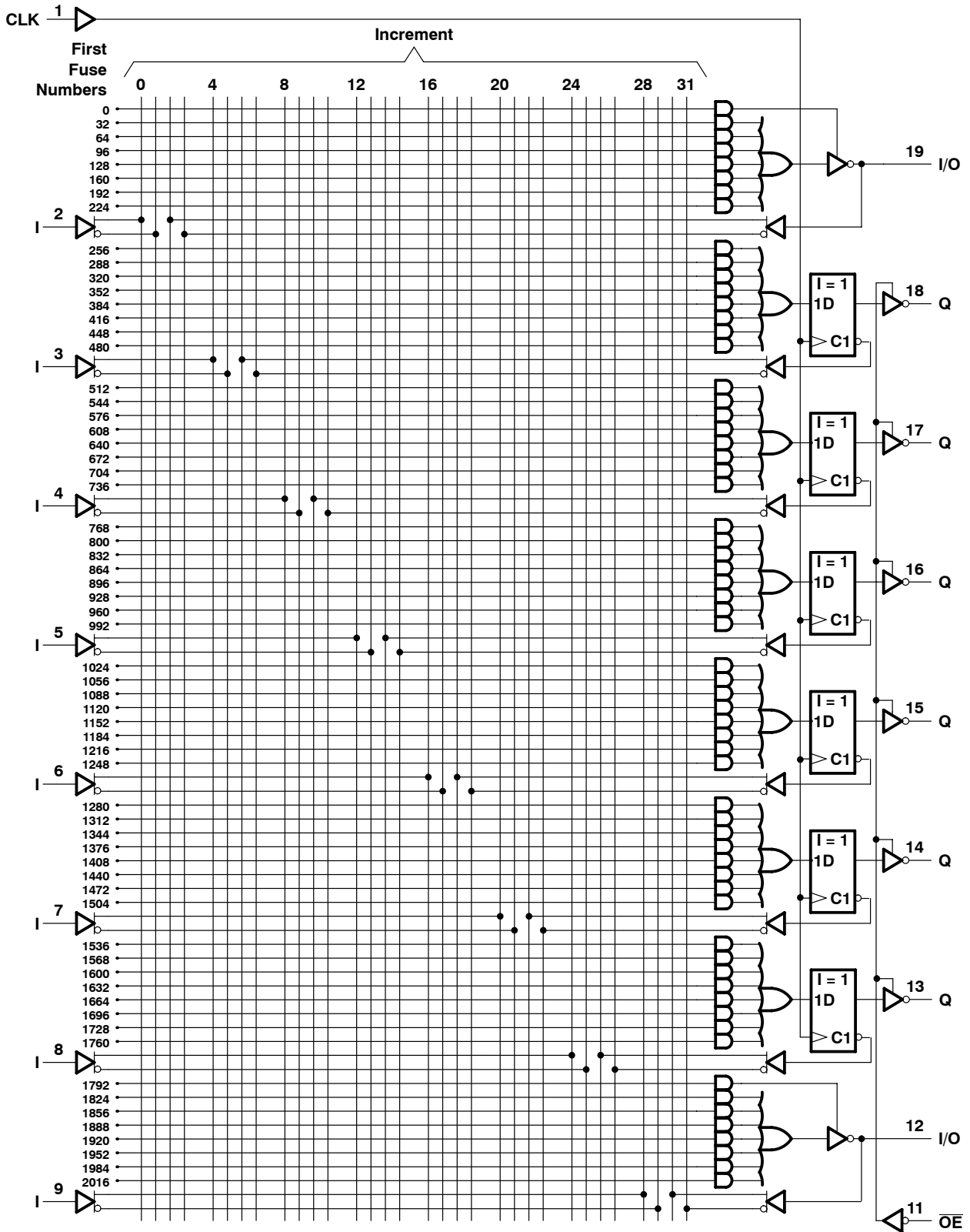


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TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C  
 TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ PAL® CIRCUITS**

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logic diagram (positive logic)



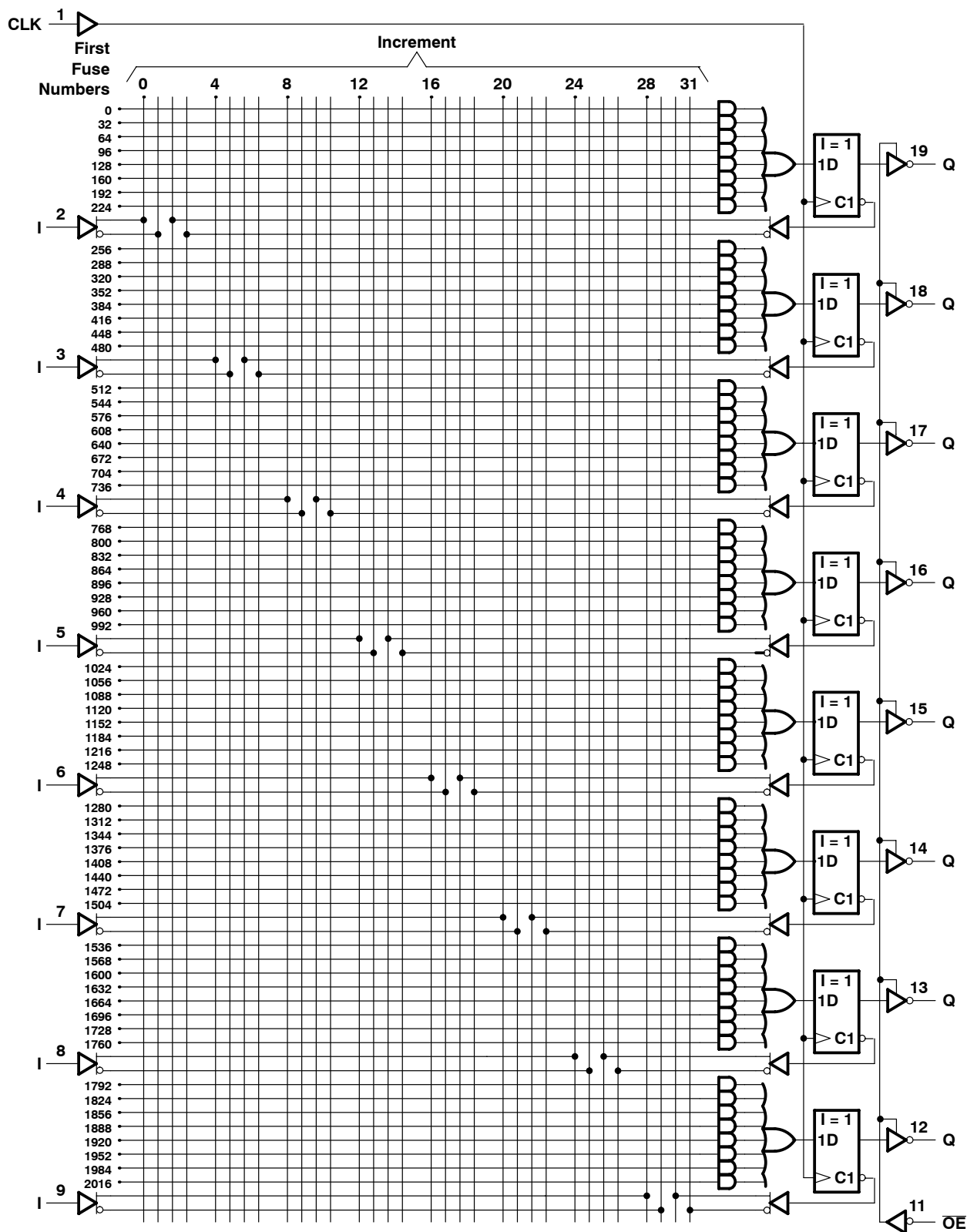
Fuse number = First fuse number + Increment



**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ PAL® CIRCUITS**

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**logic diagram (positive logic)**



Fuse number = First fuse number + Increment



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**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ *PAL*® CIRCUITS**  
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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

|   |                |
|---|----------------|
| Supply voltage, $V_{CC}$ (see Note 1) .....           | 7 V            |
| Input voltage (see Note 1) .....                      | 5.5 V          |
| Voltage applied to disabled output (see Note 1) ..... | 5.5 V          |
| Operating free-air temperature range .....            | 0°C to 75°C    |
| Storage temperature range, $T_{stg}$ .....            | –65°C to 150°C |

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

**recommended operating conditions**

|             |   | MIN  | NOM | MAX  | UNIT |
|-------------|---|------|-----|------|------|
| $V_{CC}$    | Supply voltage                              | 4.75 | 5   | 5.25 | V    |
| $V_{IH}$    | High-level input voltage                    | 2    |     | 5.5  | V    |
| $V_{IL}$    | Low-level input voltage                     |      |     | 0.8  | V    |
| $I_{OH}$    | High-level output current                   |      |     | –3.2 | mA   |
| $I_{OL}$    | Low-level output current                    |      |     | 24   | mA   |
| $f_{clock}$ | Clock frequency                             | 0    |     | 30   | MHz  |
| $t_w$       | Pulse duration, clock (see Note 2)          | High | 10  |      | ns   |
|             |   | Low  | 15  |      |      |
| $t_{su}$    | Setup time, input or feedback before clock↑ | 20   |     |      | ns   |
| $t_h$       | Hold time, input or feedback after clock↑   | 0    |     |      | ns   |
| $T_A$       | Operating free-air temperature              | 0    | 25  | 75   | °C   |

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency,  $f_{clock}$ . The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS**

SRPS059A FEBRUARY 1984 – REVISED DECEMBER 2010

**electrical characteristics over recommended operating free-air temperature range**

| PARAMETER       |           | TEST CONDITIONS            |                           | MIN | TYP† | MAX   | UNIT          |
|-----------------|-----------|----------------------------|---------------------------|-----|------|-------|---------------|
| $V_{IK}$        |           | $V_{CC} = 4.75\text{ V}$ , | $I_I = -18\text{ mA}$     |     |      | -1.5  | V             |
| $V_{OH}$        |           | $V_{CC} = 4.75\text{ V}$ , | $I_{OH} = -3.2\text{ mA}$ | 2.4 | 3.3  |       | V             |
| $V_{OL}$        |           | $V_{CC} = 4.75\text{ V}$ , | $I_{OL} = 24\text{ mA}$   |     | 0.35 | 0.5   | V             |
| $I_{OZH}$       | Outputs   | $V_{CC} = 5.25\text{ V}$ , | $V_O = 2.7\text{ V}$      |     |      | 20    | $\mu\text{A}$ |
|                 | I/O ports |                            |                           |     |      | 100   |               |
| $I_{OZL}$       | Outputs   | $V_{CC} = 5.25\text{ V}$ , | $V_O = 0.4\text{ V}$      |     |      | -20   | $\mu\text{A}$ |
|                 | I/O ports |                            |                           |     |      | -250  |               |
| $I_I$           |           | $V_{CC} = 5.25\text{ V}$ , | $V_I = 5.5\text{ V}$      |     |      | 0.1   | mA            |
| $I_{IH}$        |           | $V_{CC} = 5.25\text{ V}$ , | $V_I = 2.7\text{ V}$      |     |      | 20    | $\mu\text{A}$ |
| $I_{IL}$        |           | $V_{CC} = 5.25\text{ V}$ , | $V_I = 0.4\text{ V}$      |     |      | -0.25 | mA            |
| $I_{O\ddagger}$ |           | $V_{CC} = 5.25\text{ V}$ , | $V_O = 2.25\text{ V}$     | -30 |      | -125  | mA            |
| $I_{CC}$        |           | $V_{CC} = 5.25\text{ V}$ , | $V_I = 0$ ,               |     | 75   | 100   | mA            |
|                 |           |                            | Outputs open              |     |      |       |               |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ The output conditions have been chosen to produce a current that closely approximates one-half of the short-circuit output current,  $I_{OS}$ .

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS  | MIN | TYP† | MAX | UNIT |    |
|-----------|--------------|-------------|--|-----|------|-----|------|----|
| $f_{max}$ |              |             | R1 = 500 $\Omega$ ,<br>R2 = 500 $\Omega$ ,<br>See Figure 3 |     | 30   |     | MHz  |    |
| $t_{pd}$  | I, I/O       | O, I/O      |  |     |      | 15  | 25   | ns |
| $t_{pd}$  | CLK↑         | Q           |  |     |      | 10  | 15   | ns |
| $t_{en}$  | OE↓          | Q           |  |     |      | 15  | 20   | ns |
| $t_{dis}$ | OE↑          | Q           |  |     |      | 10  | 20   | ns |
| $t_{en}$  | I, I/O       | O, I/O      |  |     |      | 14  | 25   | ns |
| $t_{dis}$ | I, I/O       | O, I/O      |  |     |      | 13  | 25   | ns |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .



**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ *PAL*® CIRCUITS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

|   |                |
|---|----------------|
| Supply voltage, $V_{CC}$ (see Note 1) .....           | 7 V            |
| Input voltage (see Note 1) .....                      | 5.5 V          |
| Voltage applied to disabled output (see Note 1) ..... | 5.5 V          |
| Operating free-air temperature range .....            | –55°C to 125°C |
| Storage temperature range, $T_{stg}$ .....            | –65°C to 150°C |

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

**recommended operating conditions**

|             |   | MIN  | NOM | MAX | UNIT |
|-------------|---|------|-----|-----|------|
| $V_{CC}$    | Supply voltage                              | 4.5  | 5   | 5.5 | V    |
| $V_{IH}$    | High-level input voltage                    | 2    |     | 5.5 | V    |
| $V_{IL}$    | Low-level input voltage                     |      |     | 0.8 | V    |
| $I_{OH}$    | High-level output current                   |      |     | –2  | mA   |
| $I_{OL}$    | Low-level output current                    |      |     | 12  | mA   |
| $f_{clock}$ | Clock frequency                             | 0    |     | 25  | MHz  |
| $t_w$       | Pulse duration, clock (see Note 2)          | High | 15  |     | ns   |
|             |   | Low  | 20  |     |      |
| $t_{su}$    | Setup time, input or feedback before clock↑ | 25   |     |     | ns   |
| $t_h$       | Hold time, input or feedback after clock↑   | 0    |     |     | ns   |
| $T_A$       | Operating free-air temperature              | –55  | 25  | 125 | °C   |

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency,  $f_{clock}$ . The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS**

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**electrical characteristics over recommended operating free-air temperature range**

| PARAMETER         |            | TEST CONDITIONS          |                                       | MIN | TYP† | MAX   | UNIT |
|-------------------|------------|--------------------------|---------------------------------------|-----|------|-------|------|
| V <sub>IK</sub>   |            | V <sub>CC</sub> = 4.5 V, | I <sub>I</sub> = -18 mA               |     |      | -1.5  | V    |
| V <sub>OH</sub>   |            | V <sub>CC</sub> = 4.5 V, | I <sub>OH</sub> = -2 mA               | 2.4 | 3.2  |       | V    |
| V <sub>OL</sub>   |            | V <sub>CC</sub> = 4.5 V, | I <sub>OL</sub> = 12 mA               |     | 0.25 | 0.4   | V    |
| I <sub>OZH</sub>  | Outputs    | V <sub>CC</sub> = 5.5 V  | V <sub>O</sub> = 2.7 V                |     |      | 20    | μA   |
|                   | I/O ports  |                          |                                       |     |      | 100   |      |
| I <sub>OZL</sub>  | Outputs    | V <sub>CC</sub> = 5.5 V, | V <sub>O</sub> = 0.4 V                |     |      | -20   | μA   |
|                   | I/O ports  |                          |                                       |     |      | -250  |      |
| I <sub>I</sub>    | Pin 1, 11  | V <sub>CC</sub> = 5.5 V, | V <sub>I</sub> = 5.5 V                |     |      | 0.2   | mA   |
|                   | All others |                          |                                       |     |      | 0.1   |      |
| I <sub>IH</sub>   | Pin 1, 11  | V <sub>CC</sub> = 5.5 V, | V <sub>I</sub> = 2.7 V                |     |      | 50    | μA   |
|                   | I/O ports  |                          |                                       |     |      | 100   |      |
|                   | All others |                          |                                       |     |      | 20    |      |
| I <sub>IL</sub>   | I/O ports  | V <sub>CC</sub> = 5.5 V, | V <sub>I</sub> = 0.4 V                |     |      | -0.25 | mA   |
|                   | All others |                          |                                       |     |      | -0.2  |      |
| I <sub>OS</sub> ‡ |            | V <sub>CC</sub> = 5.5 V, | V <sub>O</sub> = 0.5 V                | -30 |      | -250  | mA   |
| I <sub>CC</sub>   |            | V <sub>CC</sub> = 5.5 V, | V <sub>I</sub> = 0,      Outputs open |     | 75   | 105   | mA   |

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. Set V<sub>O</sub> at 0.5 V to avoid test-equipment degradation.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS                            | MIN | TYP† | MAX | UNIT |
|------------------|--------------|-------------|--|-----|------|-----|------|
| f <sub>max</sub> |              |             | R1 = 390 Ω,<br>R2 = 750 Ω,<br>See Figure 4 | 25  |      |     | MHz  |
| t <sub>pd</sub>  | I, I/O       | O, I/O      |  |     | 15   | 30  | ns   |
| t <sub>pd</sub>  | CLK↑         | Q           |  |     | 10   | 20  | ns   |
| t <sub>en</sub>  | OE↓          | Q           |  |     | 15   | 25  | ns   |
| t <sub>dis</sub> | OE↑          | Q           |  |     | 10   | 25  | ns   |
| t <sub>en</sub>  | I, I/O       | O, I/O      |  |     | 14   | 30  | ns   |
| t <sub>dis</sub> | I, I/O       | O, I/O      |  |     | 13   | 30  | ns   |

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.



## programming information

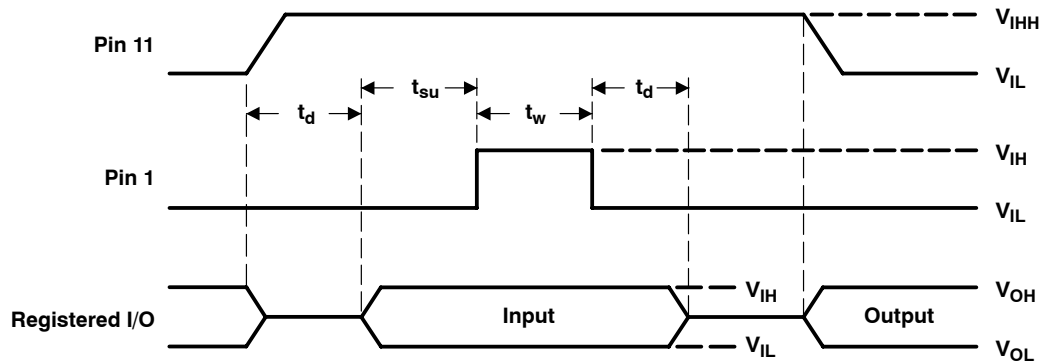
Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic also is available, upon request, from the nearest TI field sales office or local authorized TI distributor, by calling Texas Instruments at +1 (972) 644-5580, or by visiting the TI Semiconductor Home Page at [www.ti.com/sc](http://www.ti.com/sc).

## preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

- Step 1. With  $V_{CC}$  at 5 V and Pin 1 at  $V_{IL}$ , raise Pin 11 to  $V_{IHH}$ .
- Step 2. Apply either  $V_{IL}$  or  $V_{IH}$  to the output corresponding to the register to be preloaded.
- Step 3. Pulse Pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower Pin 11 to  $V_{IL}$ . Preload can be verified by observing the voltage level at the output pin.



NOTE 3:  $t_d = t_{su} = t_h = 100 \text{ ns to } 1000 \text{ ns}$   $V_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}$

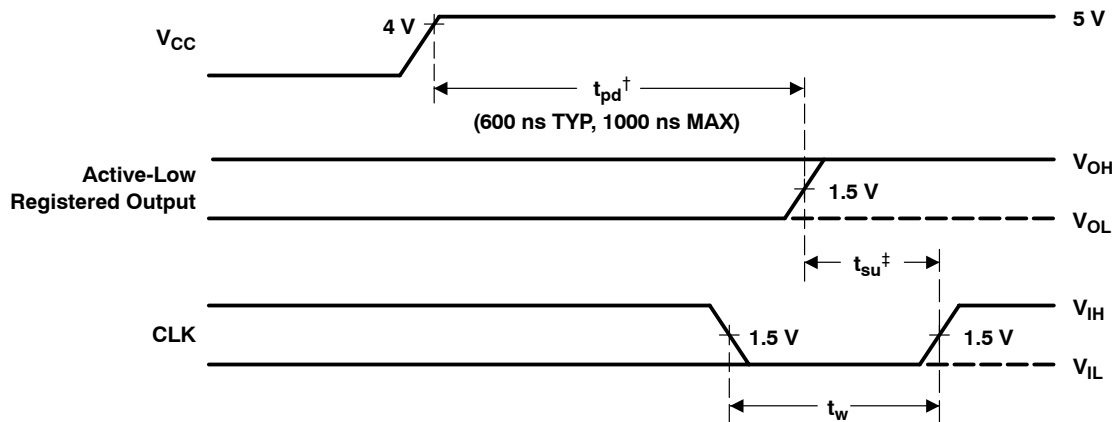
**Figure 1. Preload Waveforms**

**TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C**  
**TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M**  
**LOW-POWER HIGH-PERFORMANCE *IMPACT*™ PAL® CIRCUITS**

SRPS059A FEBRUARY 1984 – REVISED DECEMBER 2010

**power-up reset (see Figure 2)**

Following power up, all registers are set high. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of  $V_{CC}$  be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.

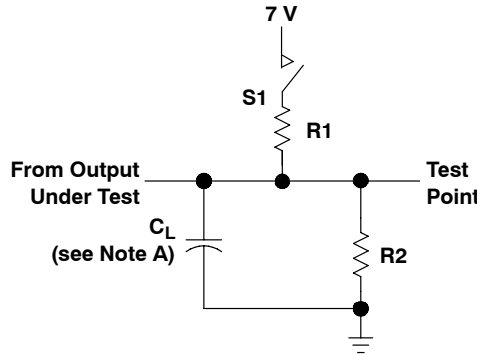


† This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

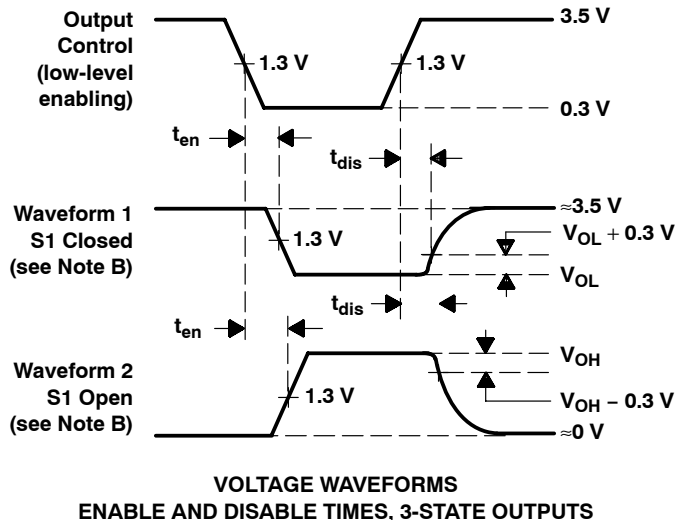
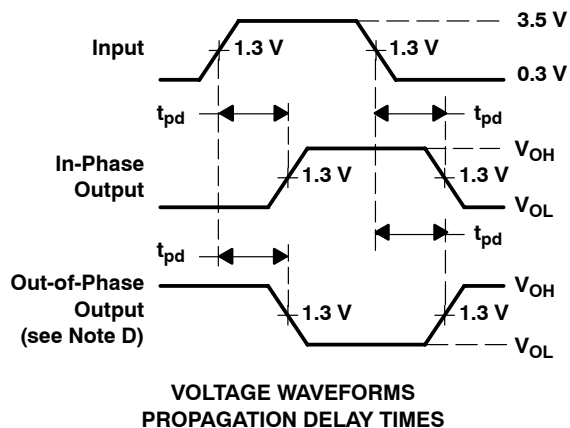
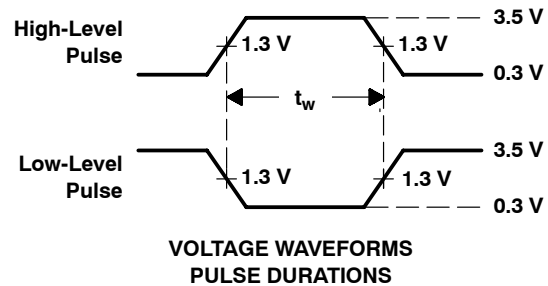
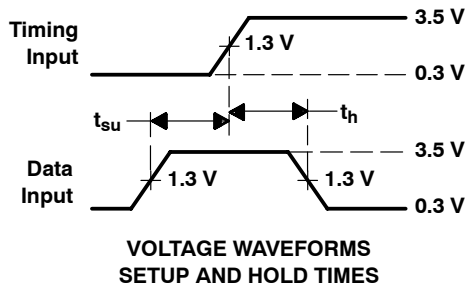
‡ This is the setup time for input or feedback.

**Figure 2. Power-Up Reset Waveforms**

**PARAMETER MEASUREMENT INFORMATION**



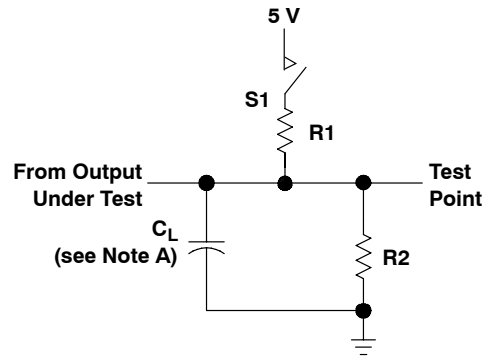
**LOAD CIRCUIT FOR 3-STATE OUTPUTS**



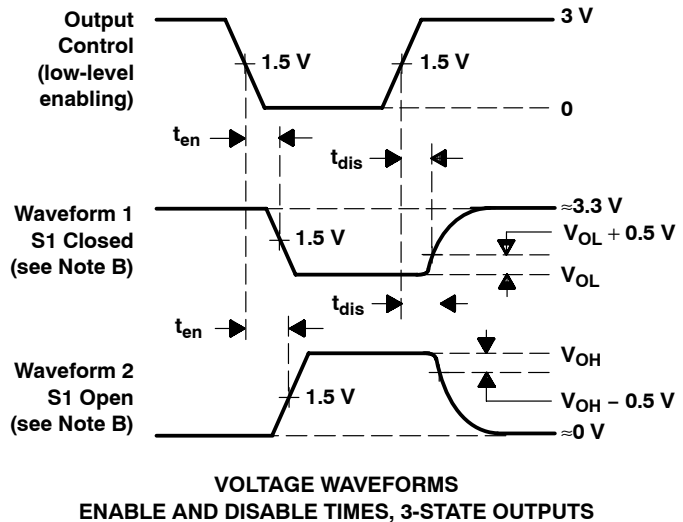
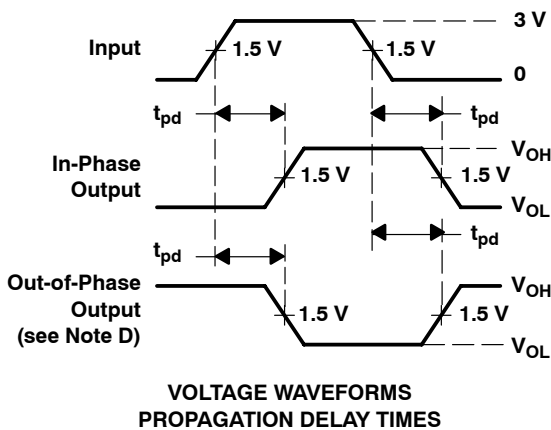
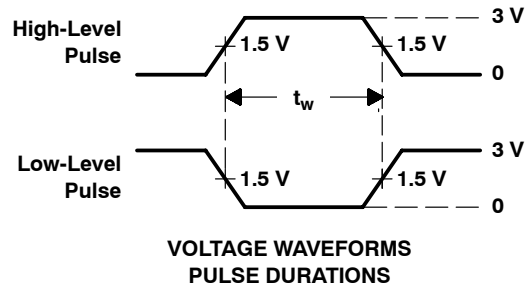
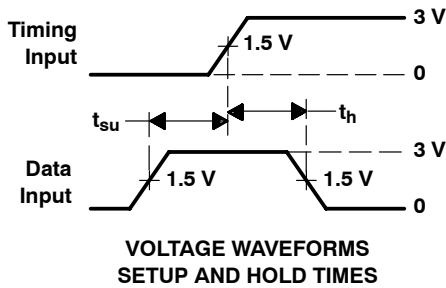
- NOTES: A.  $C_L$  includes probe and jig capacitance and is 50 pF for  $t_{pd}$  and  $t_{en}$ , 5 pF for  $t_{dis}$ .  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses have the following characteristics:  $PRR \leq 1$  MHz,  $t_r = t_f \leq 2$  ns, duty cycle = 50%  
 D. When measuring propagation delay times of 3-state outputs from low to high, switch S1 is closed. When measuring propagation delay times of 3-state outputs from high to low, switch S1 is open.  
 E. Equivalent loads may be used for testing.

**Figure 3. Load Circuit and Voltage Waveforms**

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT FOR 3-STATE OUTPUTS



- NOTES: A.  $C_L$  includes probe and jig capacitance and is 50 pF for  $t_{pd}$  and  $t_{en}$ , 5 pF for  $t_{dis}$ .  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses have the following characteristics:  $PRR \leq 10$  MHz,  $t_r = t_f \leq 2$  ns, duty cycle = 50%  
 D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.  
 E. Equivalent loads may be used for testing.

Figure 4. Load Circuit and Voltage Waveforms



**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                     | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------|----------------------|--------------|---|-------------------------|
| 5962-85155052A   | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155052A<br>TIBPAL16<br>L8-30MFKB | <a href="#">Samples</a> |
| 5962-8515505RA   | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515505RA<br>TIBPAL16L8-30M<br>JB      | <a href="#">Samples</a> |
| 5962-8515505SA   | ACTIVE        | CFP          | W                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515505SA<br>TIBPAL16L8-30M<br>WB      | <a href="#">Samples</a> |
| 5962-85155062A   | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155062A<br>TIBPAL16<br>R8-30MFKB | <a href="#">Samples</a> |
| 5962-8515506RA   | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515506RA<br>TIBPAL16R8-30M<br>JB      | <a href="#">Samples</a> |
| 5962-8515506SA   | ACTIVE        | CFP          | W                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515506SA<br>TIBPAL16R8-30M<br>WB      | <a href="#">Samples</a> |
| 5962-85155072A   | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155072A<br>TIBPAL16<br>R6-30MFKB | <a href="#">Samples</a> |
| 5962-8515507RA   | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515507RA<br>TIBPAL16R6-30M<br>JB      | <a href="#">Samples</a> |
| 5962-85155082A   | ACTIVE        | LCCC         | FK                 | 20   | 1              | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155082A<br>TIBPAL16<br>R4-30MFKB | <a href="#">Samples</a> |
| 5962-8515508RA   | ACTIVE        | CDIP         | J                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515508RA<br>TIBPAL16R4-30M<br>JB      | <a href="#">Samples</a> |
| 5962-8515508SA   | ACTIVE        | CFP          | W                  | 20   | 1              | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515508SA<br>TIBPAL16R4-30M<br>WB      | <a href="#">Samples</a> |

| Orderable Device  | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                     | Samples                 |
|-------------------|---------------|--------------|-----------------|------|-------------|-----------------|-------------------------|----------------------|--------------|---|-------------------------|
| JM38510/50605BRA  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50605BRA                        | <a href="#">Samples</a> |
| JM38510/50606BRA  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50606BRA                        | <a href="#">Samples</a> |
| JM38510/50608BRA  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50608BRA                        | <a href="#">Samples</a> |
| M38510/50605BRA   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50605BRA                        | <a href="#">Samples</a> |
| M38510/50606BRA   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50606BRA                        | <a href="#">Samples</a> |
| M38510/50608BRA   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | JM38510/<br>50608BRA                        | <a href="#">Samples</a> |
| TIBPAL16L8-30MFKB | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155052A<br>TIBPAL16<br>L8-30MFKB | <a href="#">Samples</a> |
| TIBPAL16L8-30MJ   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | TIBPAL16L8-30M<br>J                         | <a href="#">Samples</a> |
| TIBPAL16L8-30MJB  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515505RA<br>TIBPAL16L8-30M<br>JB      | <a href="#">Samples</a> |
| TIBPAL16L8-30MWB  | ACTIVE        | CFP          | W               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515505SA<br>TIBPAL16L8-30M<br>WB      | <a href="#">Samples</a> |
| TIBPAL16R4-30MFKB | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155082A<br>TIBPAL16<br>R4-30MFKB | <a href="#">Samples</a> |
| TIBPAL16R4-30MJ   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | TIBPAL16R4-30M<br>J                         | <a href="#">Samples</a> |
| TIBPAL16R4-30MJB  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515508RA<br>TIBPAL16R4-30M<br>JB      | <a href="#">Samples</a> |
| TIBPAL16R4-30MWB  | ACTIVE        | CFP          | W               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515508SA<br>TIBPAL16R4-30M<br>WB      | <a href="#">Samples</a> |
| TIBPAL16R6-30MFKB | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-                                       | <a href="#">Samples</a> |

| Orderable Device  | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                     | Samples                 |
|-------------------|---------------|--------------|-----------------|------|-------------|-----------------|-------------------------|----------------------|--------------|---|-------------------------|
|                   |               |              |                 |      |             |                 |                         |                      |              | 85155072A<br>TIBPAL16<br>R6-30MFKB          |                         |
| TIBPAL16R6-30MJ   | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | TIBPAL16R6-30M<br>J                         | <a href="#">Samples</a> |
| TIBPAL16R6-30MJB  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515507RA<br>TIBPAL16R6-30M<br>JB      | <a href="#">Samples</a> |
| TIBPAL16R8-30MFKB | ACTIVE        | LCCC         | FK              | 20   | 1           | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>85155062A<br>TIBPAL16<br>R8-30MFKB | <a href="#">Samples</a> |
| TIBPAL16R8-30MJB  | ACTIVE        | CDIP         | J               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515506RA<br>TIBPAL16R8-30M<br>JB      | <a href="#">Samples</a> |
| TIBPAL16R8-30MWB  | ACTIVE        | CFP          | W               | 20   | 1           | TBD             | Call TI                 | N / A for Pkg Type   | -55 to 125   | 5962-8515506SA<br>TIBPAL16R8-30M<br>WB      | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

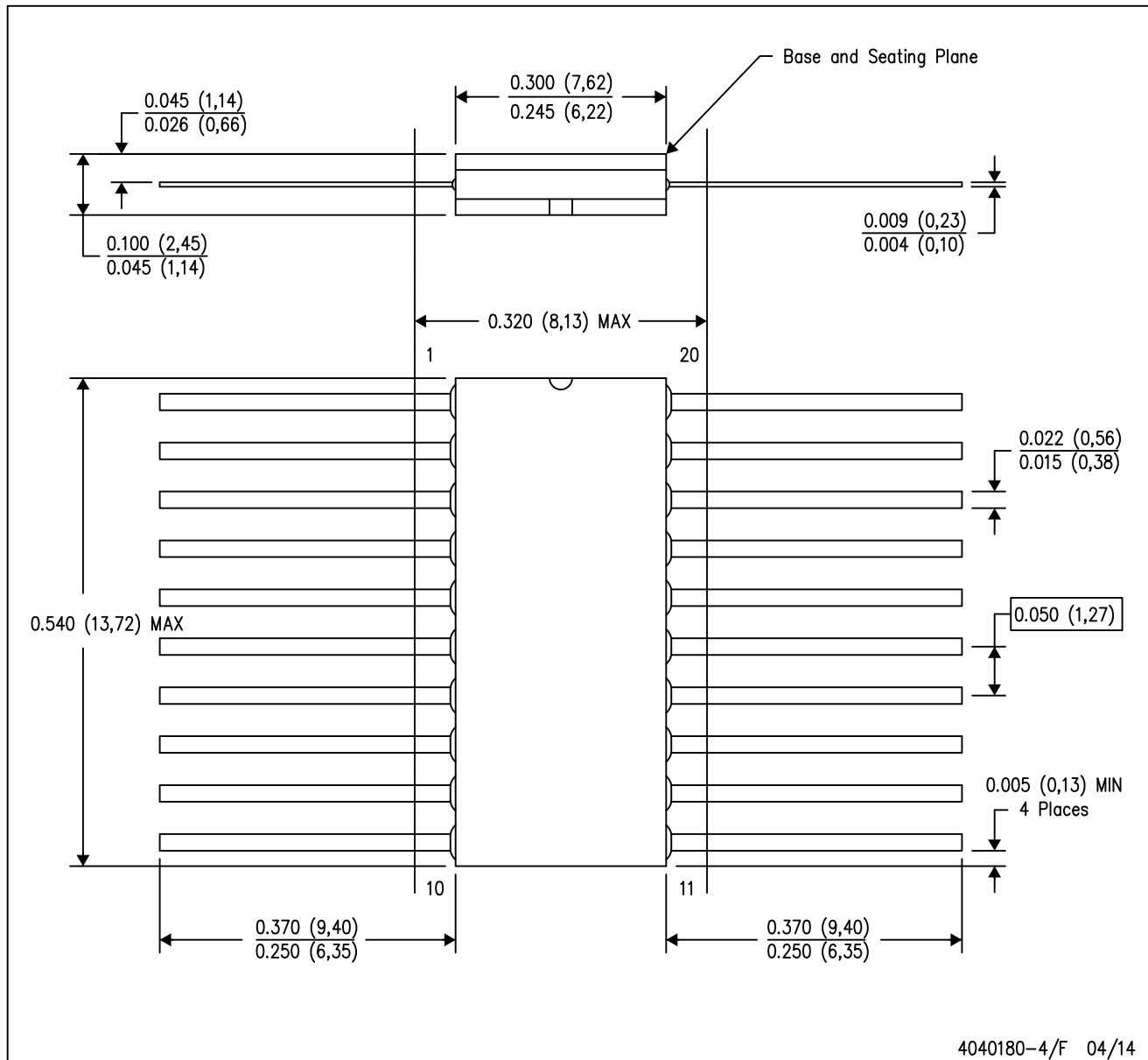
<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A                |                  | B                |                  |
|---------------------|------------------|------------------|------------------|------------------|
|                     | MIN              | MAX              | MIN              | MAX              |
| 20                  | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                  | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                  | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                  | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                  | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                  | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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